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(54) **CONNECTOR HOUSING FOR ELECTRICAL CONNECTOR**

(71) Applicant: **FCI Americas Technology LLC**,
Carson City, NV (US)

(72) Inventors: **Donald K. Harper, Jr.**, York, PA (US);
Lewis Robin Johnson, Dover, PA (US)

(73) Assignee: **FCI Americas Technology LLC**,
Carson City, NV (US)

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(52) **U.S. Cl.**
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(58) **Field of Classification Search**
USPC D13/147, 154, 184, 199
See application file for complete search history.

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Primary Examiner — Daniel Bui

(74) *Attorney, Agent, or Firm* — Wolf, Greenfield & Sacks, P.C.

(57) **CLAIM**

The ornamental design for a connector housing for electrical connector, as shown and described.

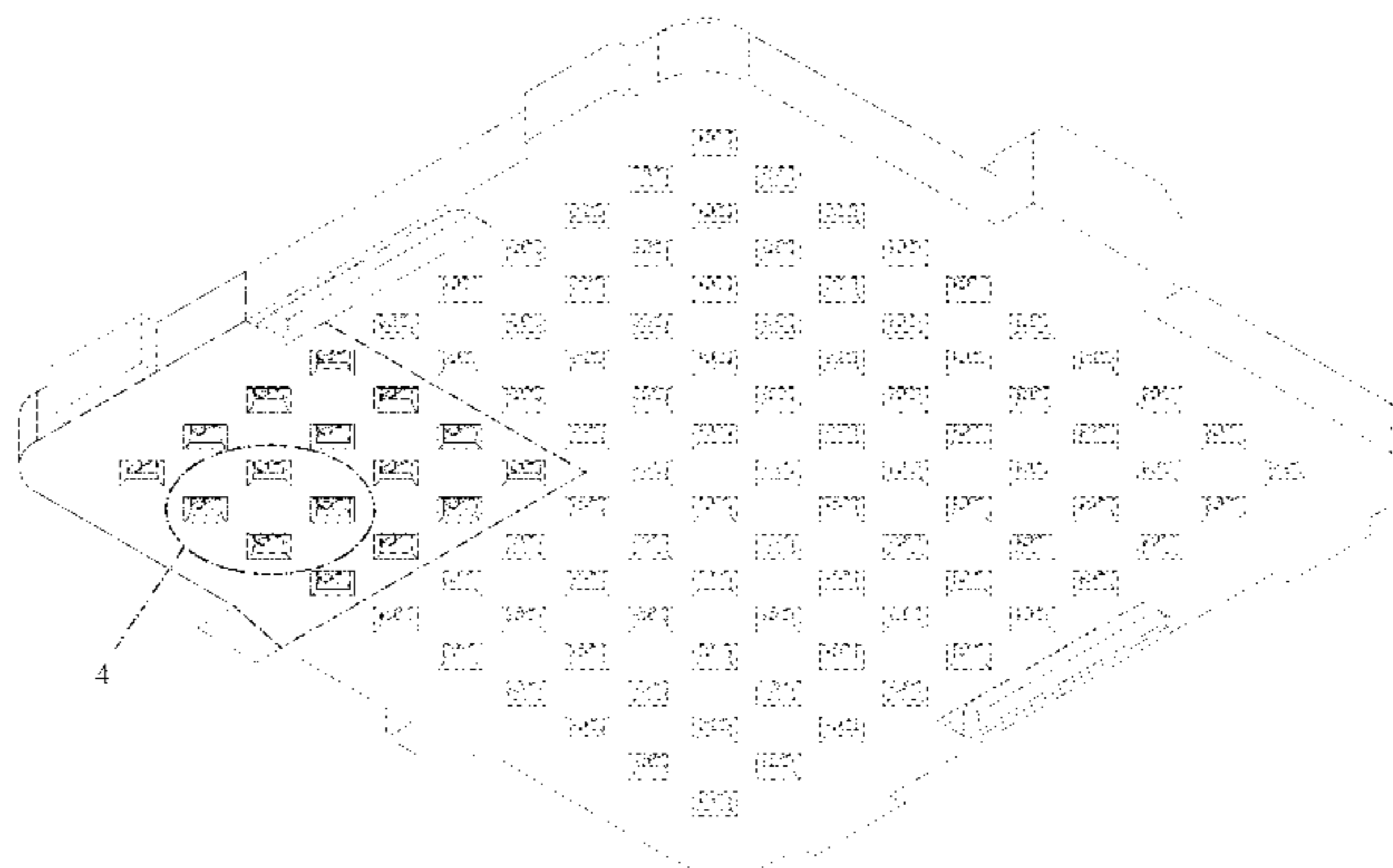
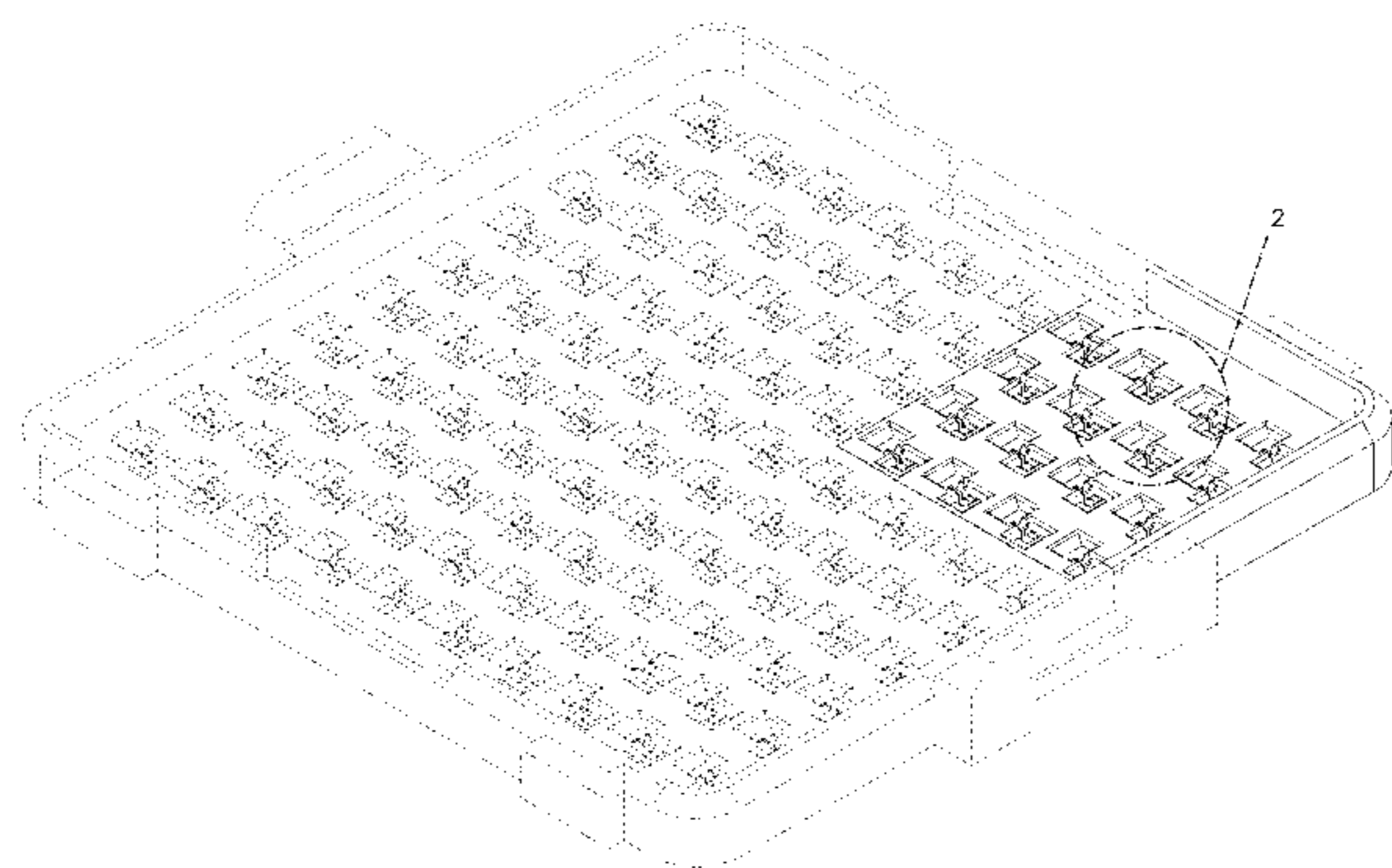
DESCRIPTION

FIG. 1 is a top, left, front perspective view of a connector housing for electrical connector showing our new design; FIG. 2 is a larger view of area 2 as illustrated in FIG. 1; FIG. 3 is a bottom, right, rear perspective view of our new connector housing for electrical connector thereof; FIG. 4 is a larger view of area 4 as illustrated in FIG. 3; FIG. 5 is a bottom, left, front perspective view of our new connector housing for electrical connector thereof; FIG. 6 is a larger view of area 6 as illustrated in FIG. 5; FIG. 7 is a top, left, rear perspective view of our new connector housing for electrical connector thereof; FIG. 8 is a larger view of area 8 as illustrated in FIG. 7; FIG. 9 is a left side elevation view of our new connector housing for electrical connector thereof; FIG. 10 is a right side elevation view thereof; FIG. 11 is a front elevation view thereof; FIG. 12 is a rear elevation view thereof; FIG. 13 is a bottom plan view thereof; and, FIG. 14 is a top plan view thereof.

The broken line portion of the figure drawings is included to show unclaimed subject matter only for the purpose of illustrating environment and forms no part of the claimed design.

In a preferred embodiment, the nature of this product is an electrical component that can take the form of a connector housing for an electrical connector.

1 Claim, 10 Drawing Sheets



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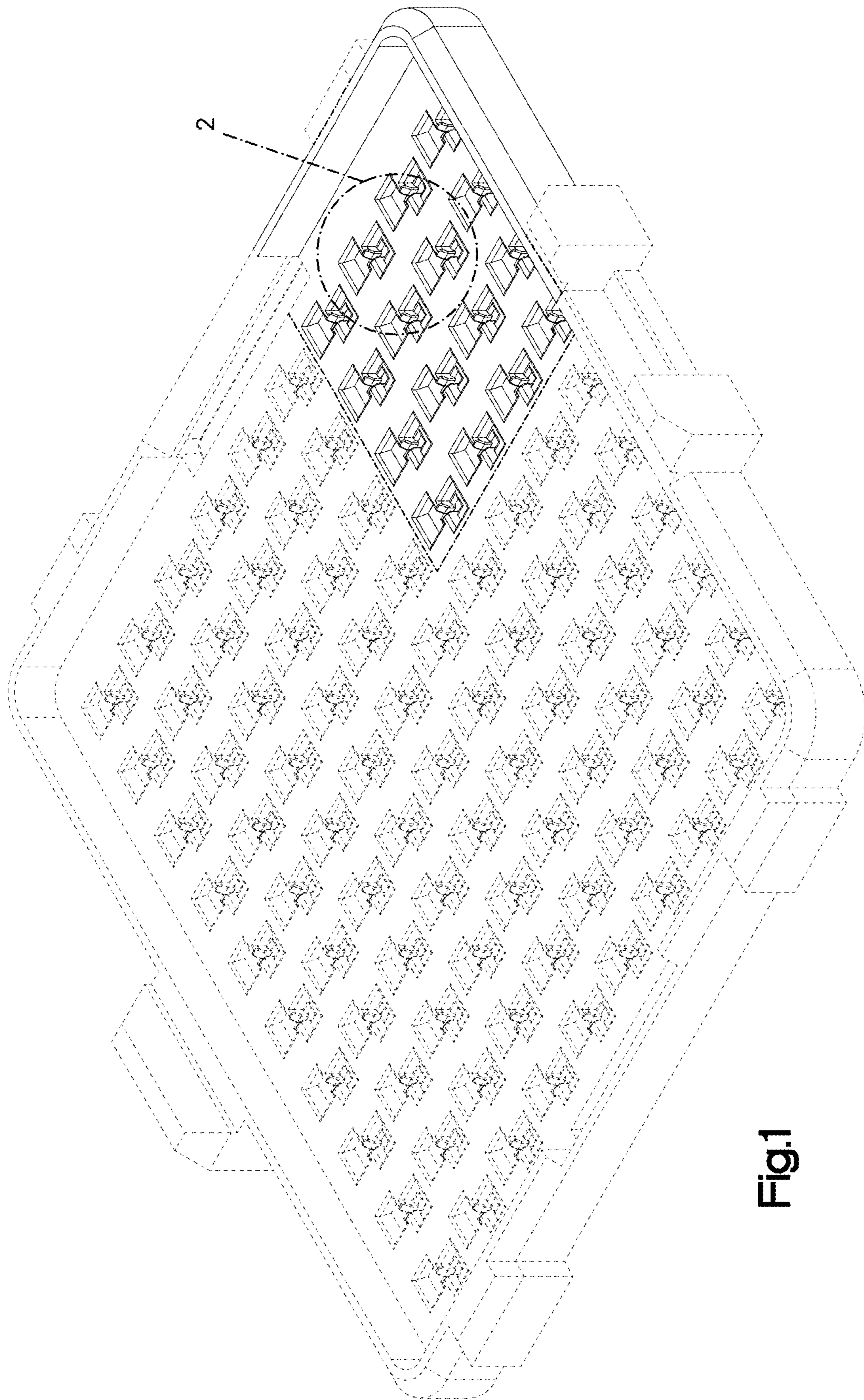


Fig.1

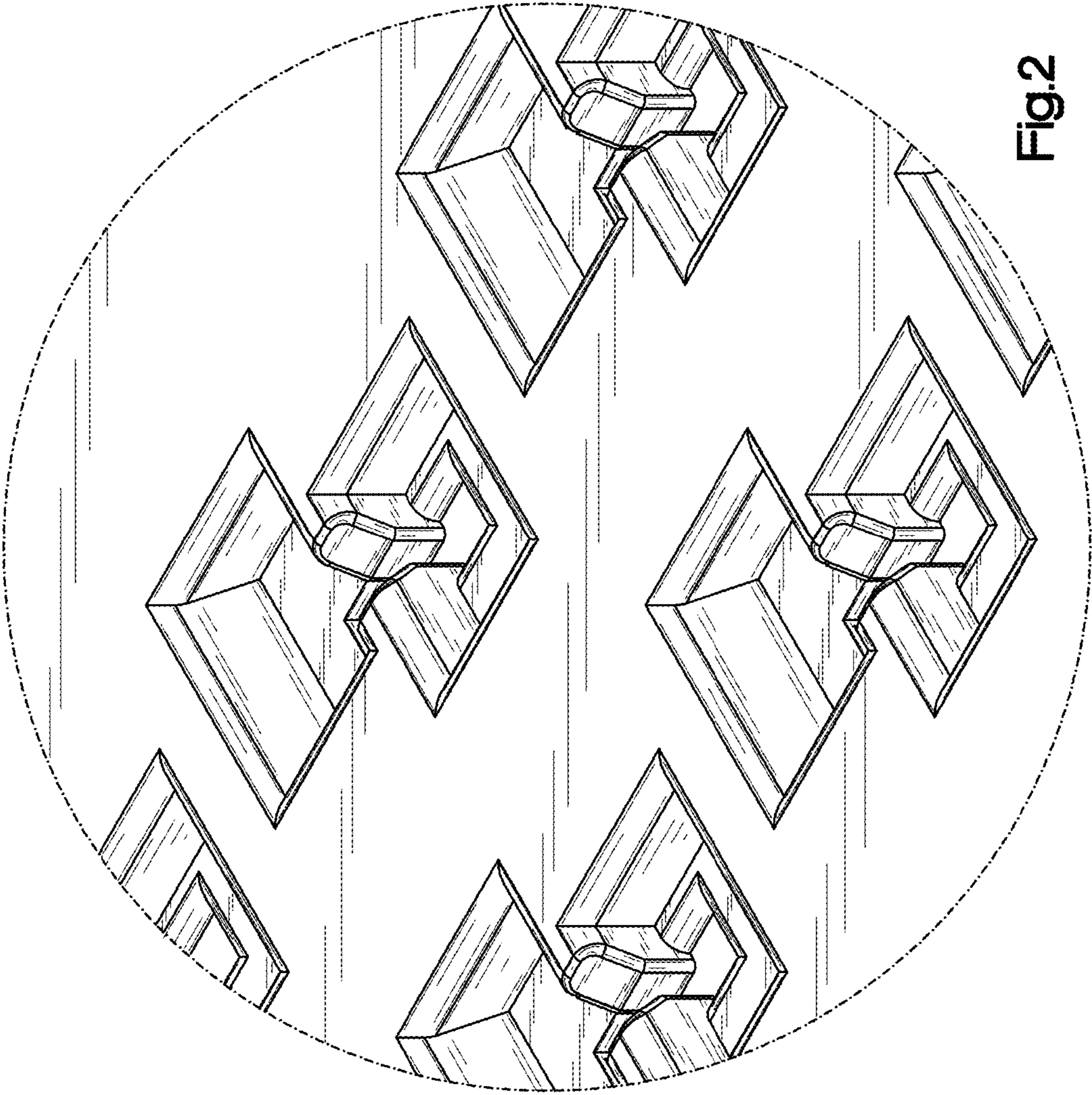


Fig. 2

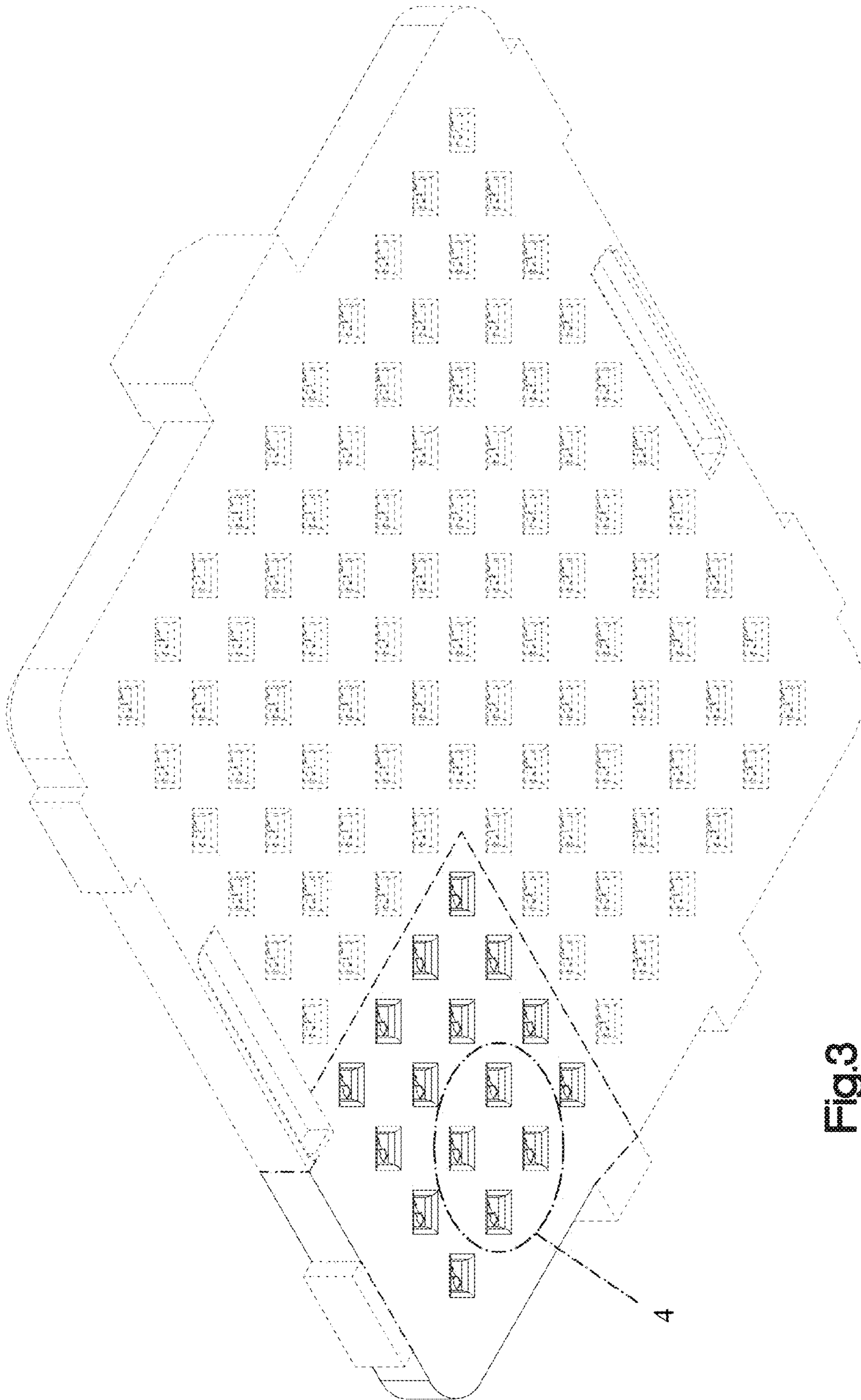


Fig.3

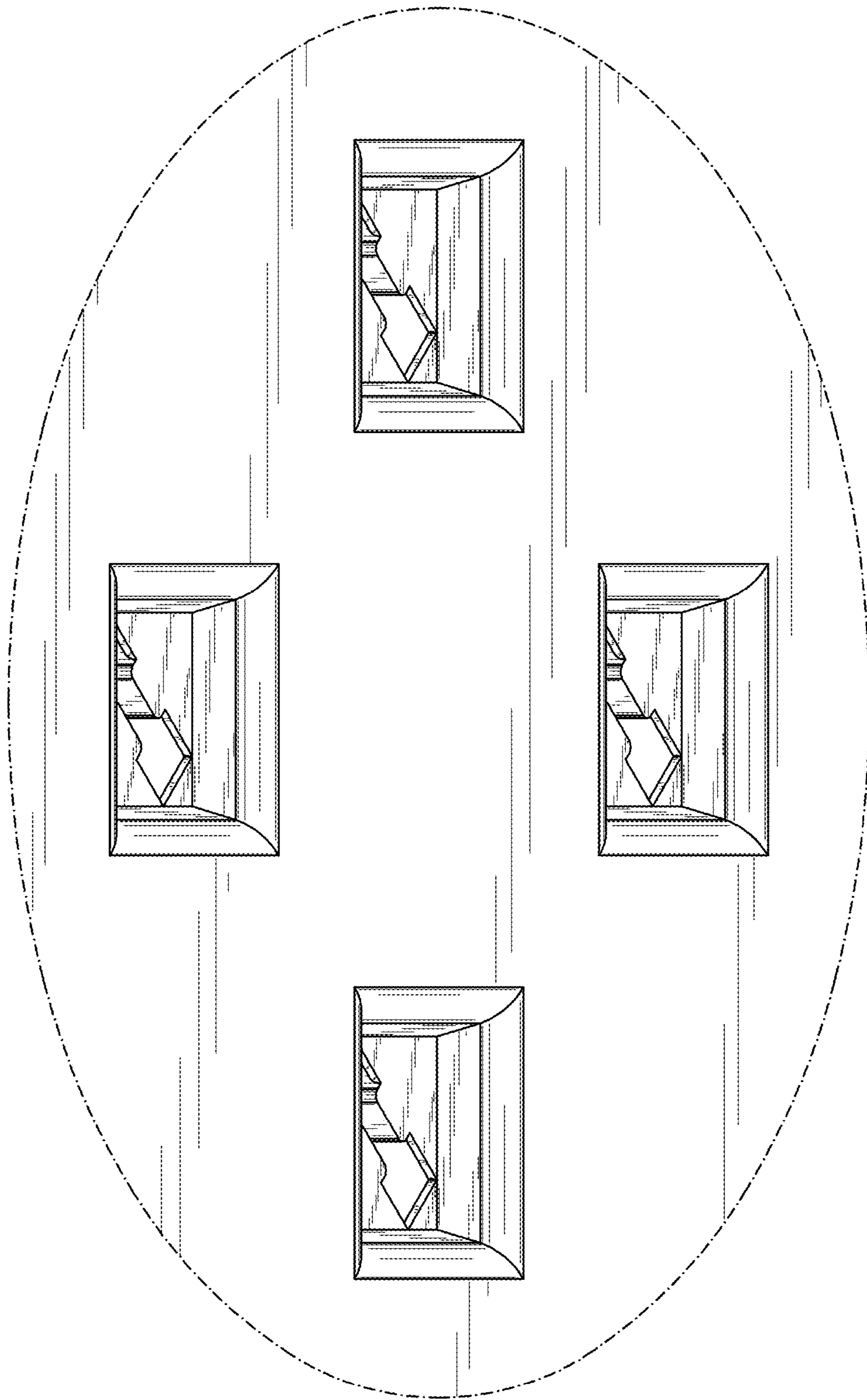


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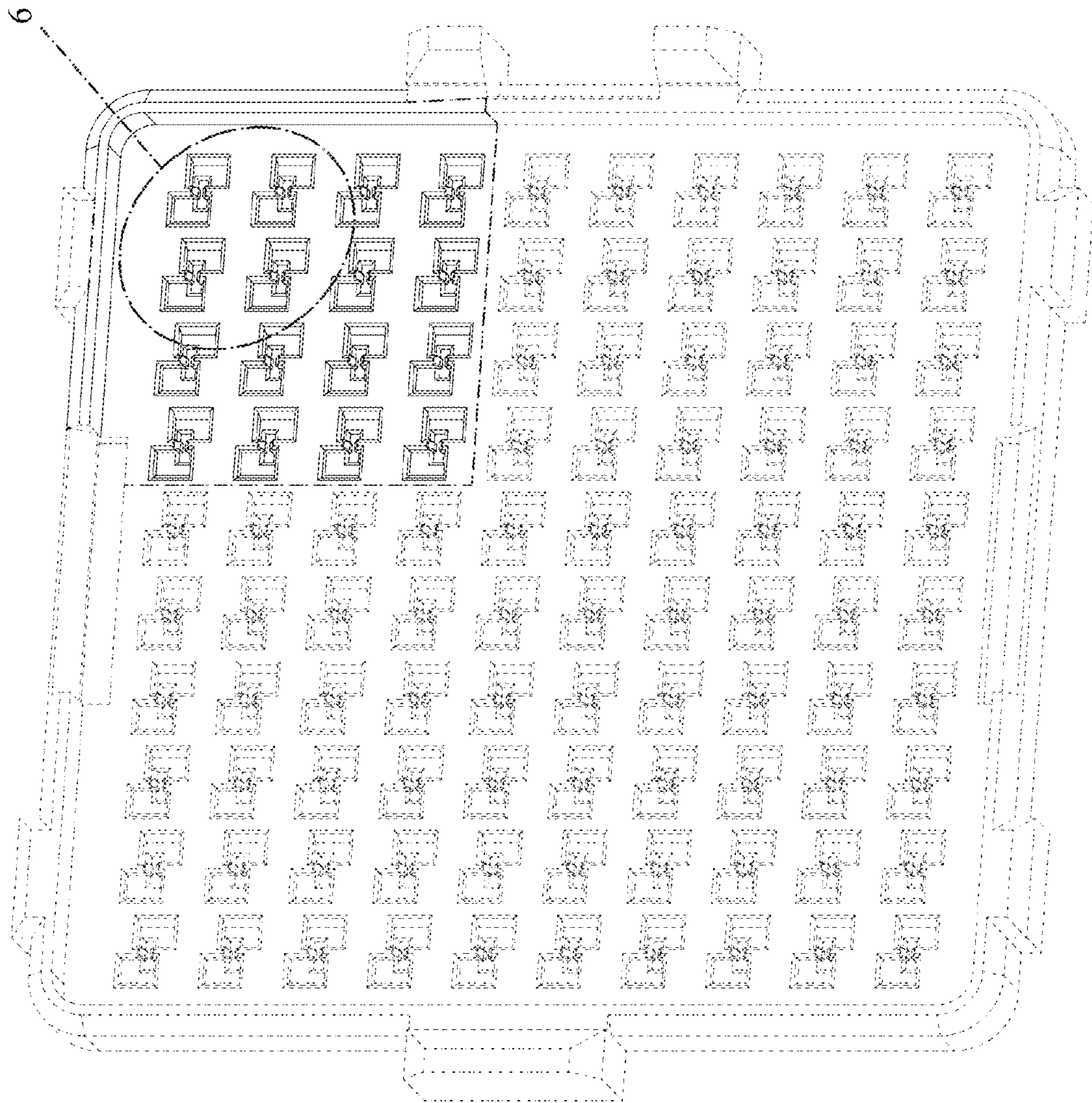


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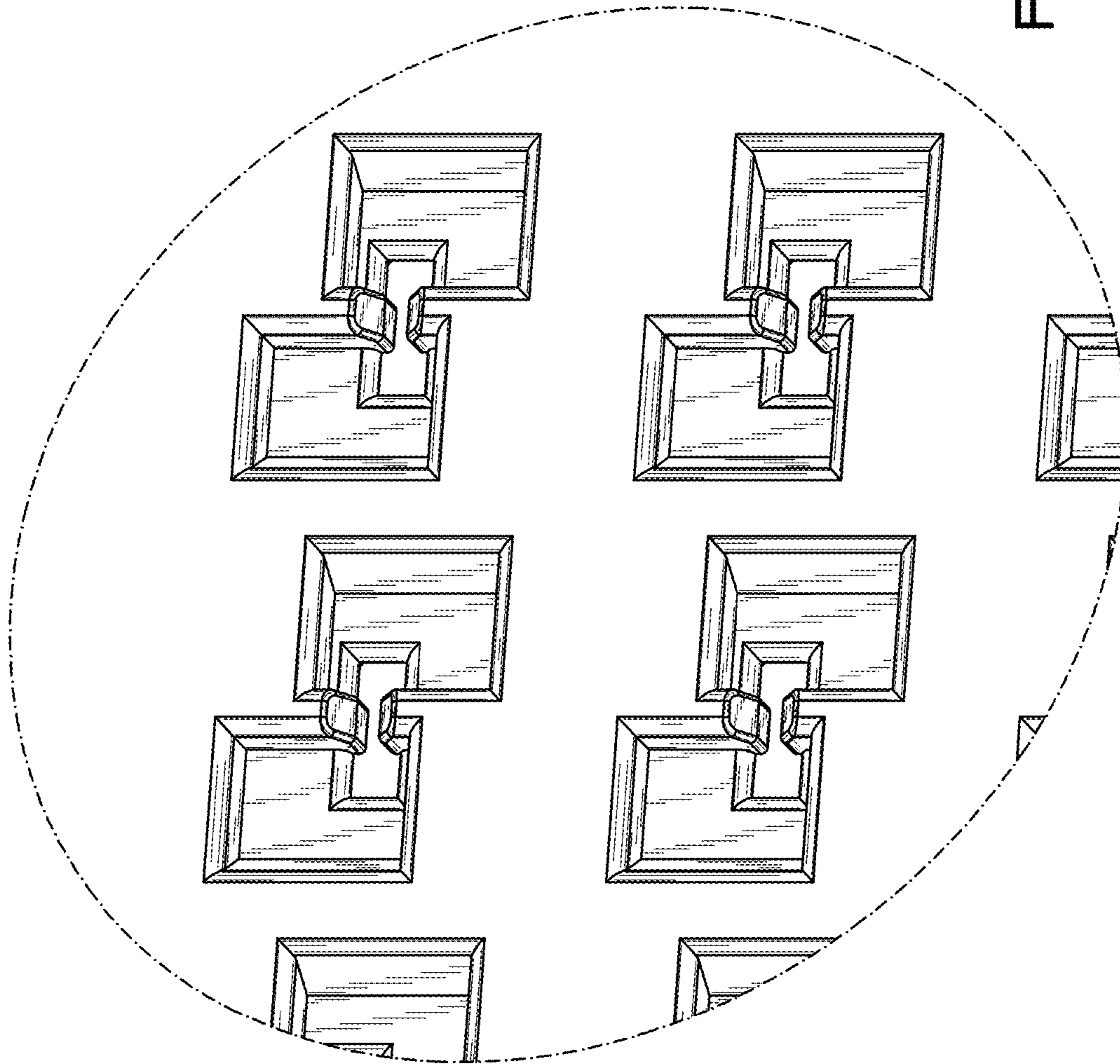


Fig.6

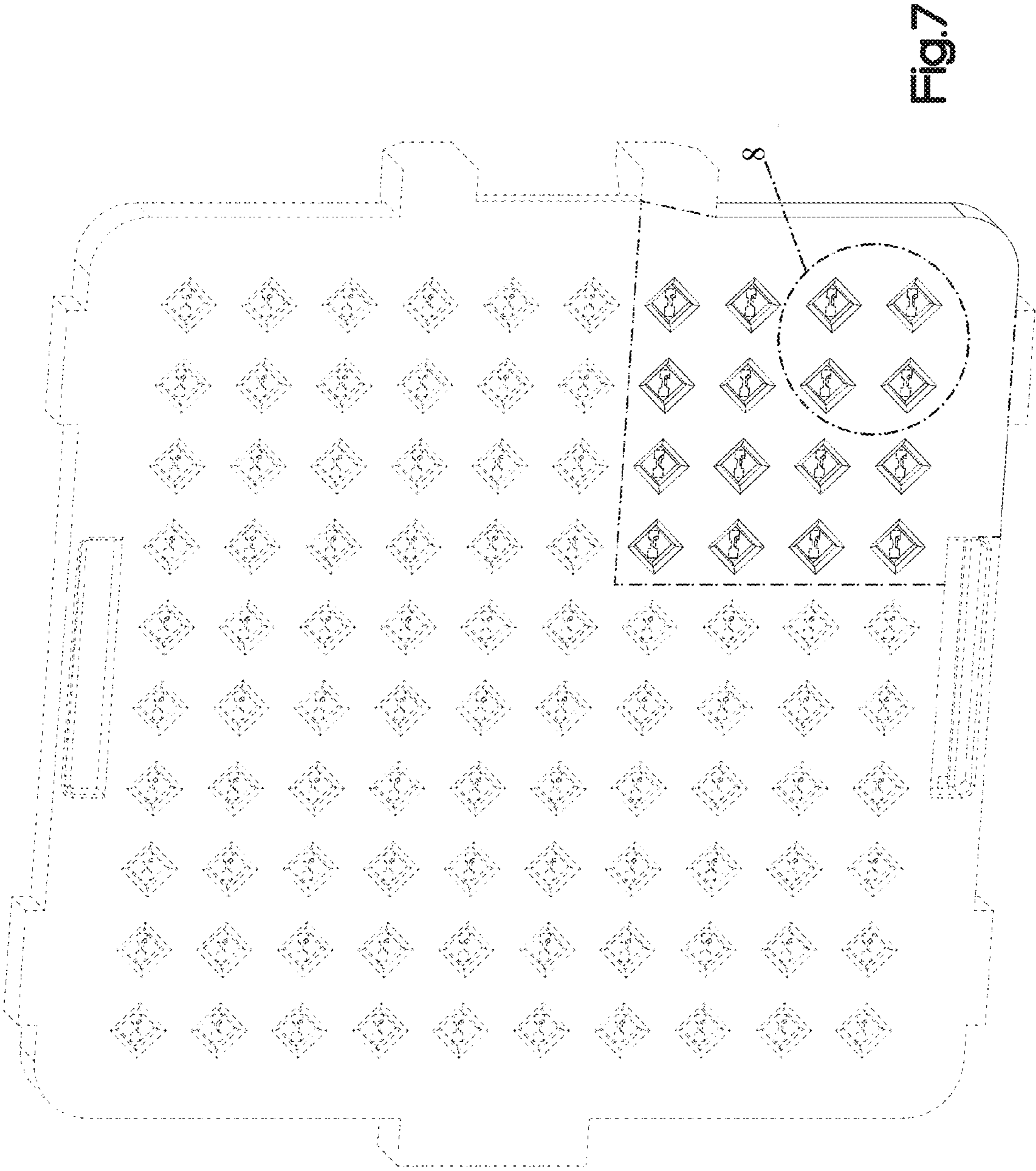


Fig. 7

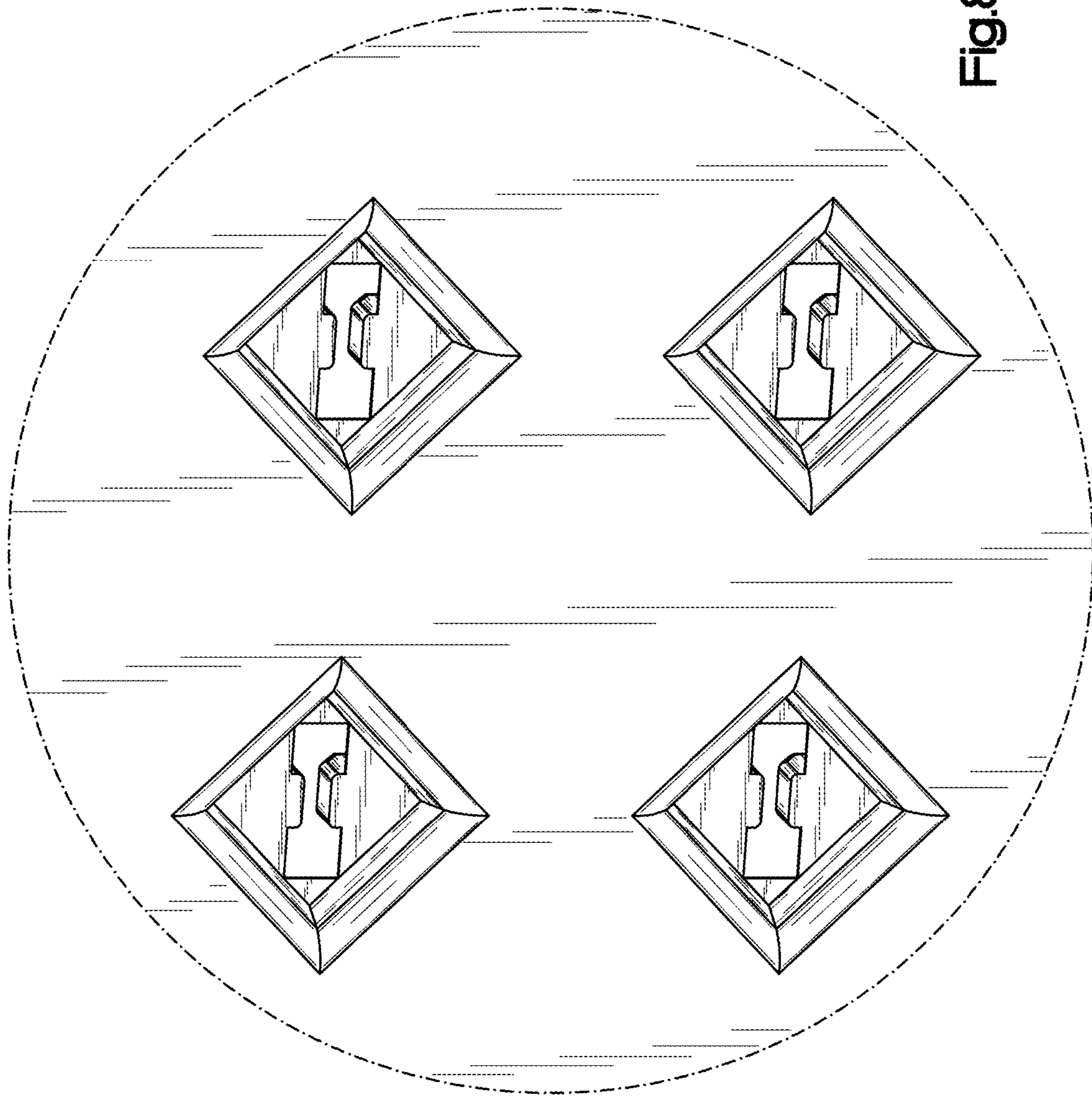


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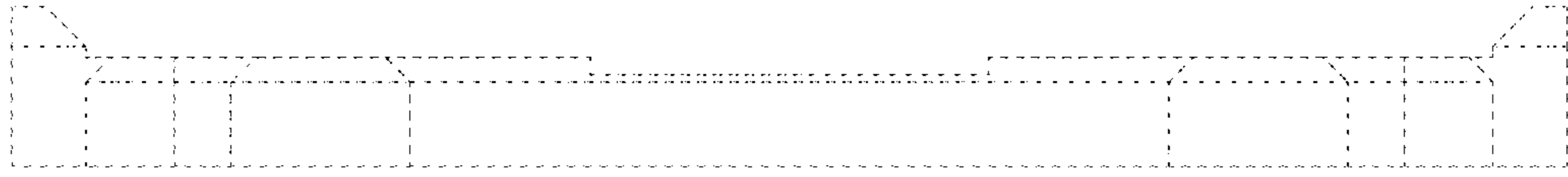


Fig.9

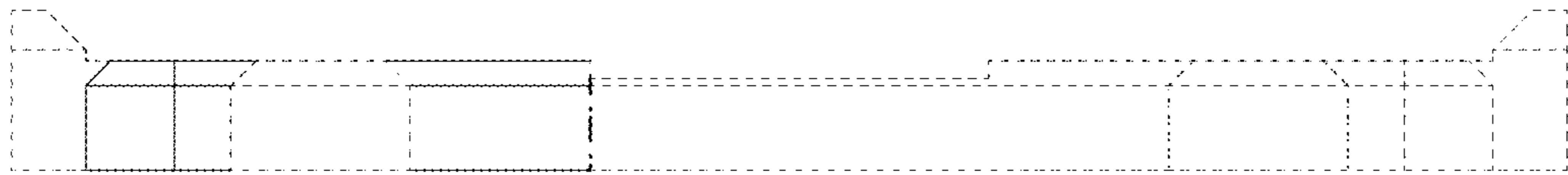


Fig.10

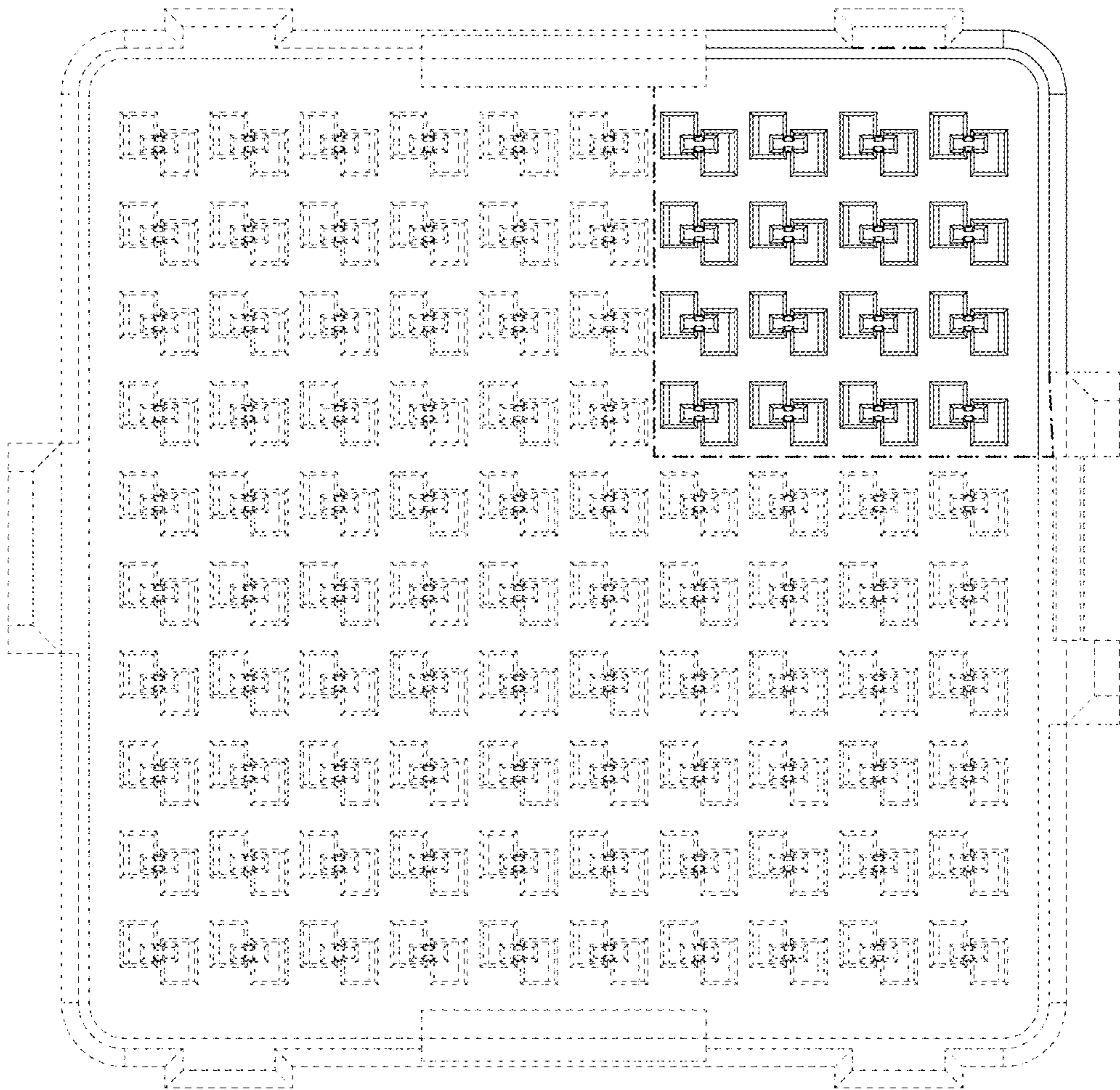


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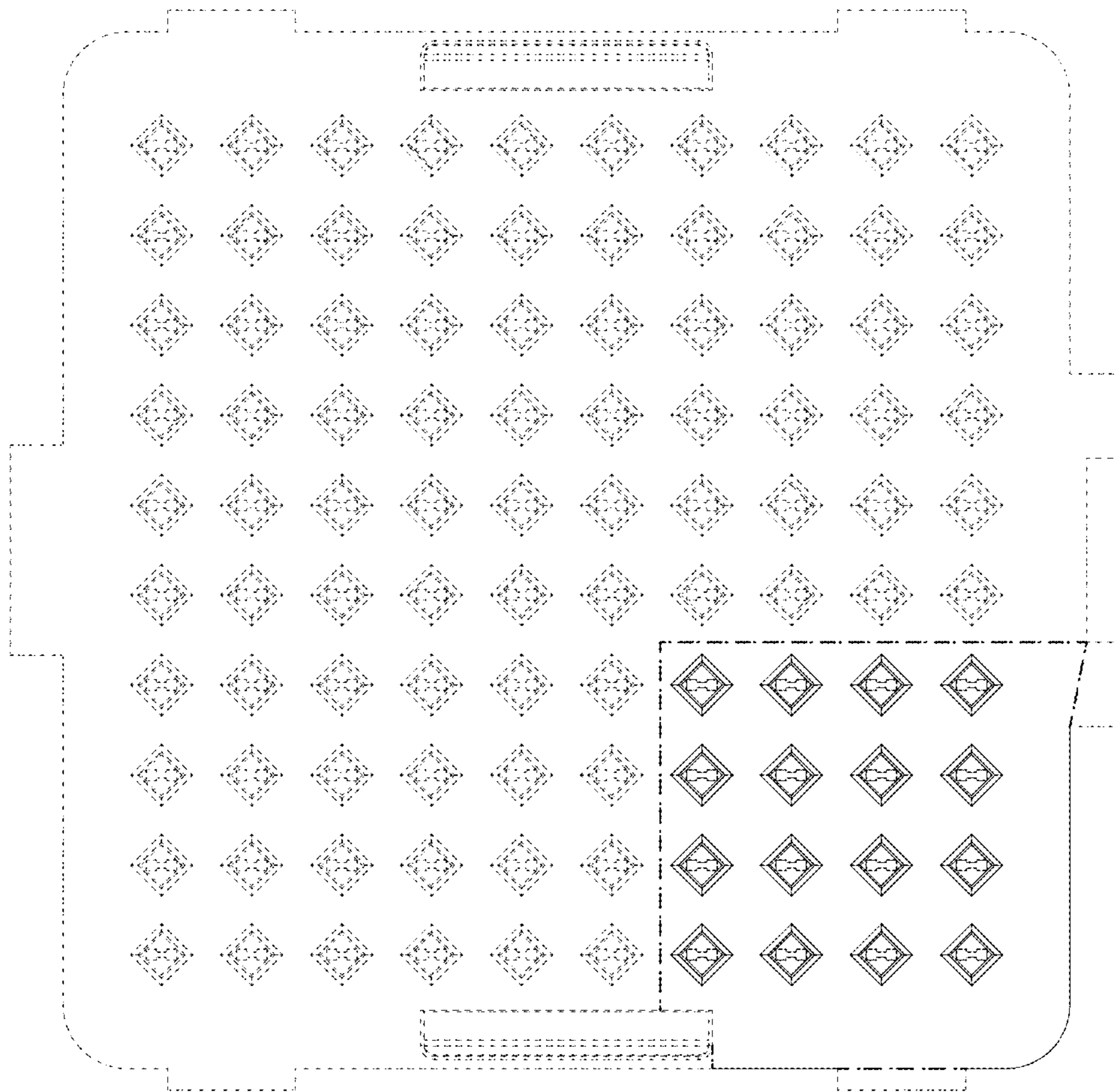


Fig.12



Fig.13

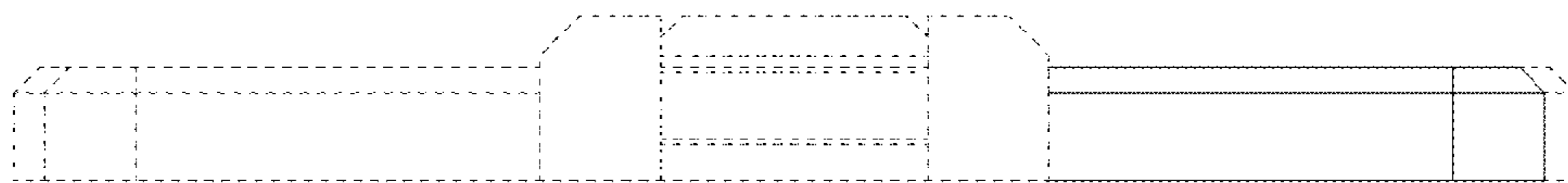


Fig.14